

SPECIFICATION

DCD-MX80

For Customer's Acceptance:

Approved By	Comment		
PREPARED	CHECKED	VERIFIED BY QA DEPT	VERIFIED BY R&D DEPT

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1. General Specifications

No.	Item	Specification	Remark
1	LCD size	8.0 inch diagonal	
2	Driver element	a-Si TFT active matrix	
3	Resolution	1024 × 3(RGB) × 768	
4	Display mode	Normally Black, Transmissive	
5	Dot pitch	0.05275(W) × 0.15825(H) mm	
6	Active area	162.05(W) × 121.54(H) mm	
7	Module size	183.00 (W) × 141.00(H) × 5.5(D) mm	Note 1
8	Surface treatment	Hard Coating	
9	Color arrangement	RGB-stripe	
10	Interface	LVDS	
11	Backlight power consumption	3.456W	
12	Panel power consumption	0.383W	
13	Weight	TBD	

Note 1: Refer to Mechanical Drawing.

2. Pin Assignment

2.1 CN1 (Input Signal)

Pin No.	Symbol	I/O	Function	Remark
1	VCOM	P	Common Voltage	
2	VDD	P	Power Voltage for digital circuit	
3	VDD	P	Power Voltage for digital circuit	
4	NC	---	No connection	
5	Reset	I	Global reset pin	
6	STBYB	I	Standby mode, Normally pulled high STBYB = "1", normal operation STBYB = "0", timing controller, source driver will turn off, all output are High-Z	
7	GND	P	Ground	
8	RXIN0-	I	- LVDS differential data input	
9	RXIN0+	I	+ LVDS differential data input	
10	GND	P	Ground	
11	RXIN1-	I	- LVDS differential data input	
12	RXIN1+	I	+ LVDS differential data input	
13	GND	P	Ground	
14	RXIN2-	I	- LVDS differential data input	
15	RXIN2+	I	+ LVDS differential data input	
16	GND	P	Ground	
17	RXCLKIN-	I	- LVDS differential clock input	
18	RXCLKIN+	I	+ LVDS differential clock input	
19	GND	P	Ground	
20	RXIN3-	I	- LVDS differential data input	
21	RXIN3+	I	+ LVDS differential data input	
22	GND	P	Ground	
23	NC	---	No connection	
24	NC	---	No connection	
25	GND	P	Ground	
26	NC	---	No connection	

27	DIMO	O	Backlight CABC controller signal output	
28	SELB	I	6bit/8bit mode select	Note1
29	AVDD	P	Power for Analog Circuit	
30	GND	P	Ground	
31	NC	---	No connection	
32	NC	---	No connection	
33	L/R	I	Horizontal inversion	Note3
34	U/D	I	Vertical inversion	Note3
35	VGL	P	Gate OFF Voltage	
36	CABCEN1	I	CABC H/W enable	Note2
37	CABCEN0	I	CABC H/W enable	Note2
38	VGH	P	Gate ON Voltage	
39	NC	---	No connection	
40	NC	---	No connection	

I: input, O: output, P: Power

Note1: If LVDS input data is 6 bits ,SELB must be set to High;

If LVDS input data is 8 bits ,SELB must be set to Low.

Note2: When CABC_EN="00", CABC OFF.

When CABC_EN="01", user interface image.

When CABC_EN="10", still picture.

When CABC_EN="11", moving image.

When CABC off, don't connect DIMO, else connect it to backlight.

Note3: When L/R="0", set right to left scan direction.

When L/R="1", set left to right scan direction.

When U/D="0", set top to bottom scan direction.

When U/D="1", set bottom to top scan direction.

2.2 CN2 (LED backlight)

PIN NO	SYMBOL	FUNCTION
1	A	Anode
2	K	Cathode

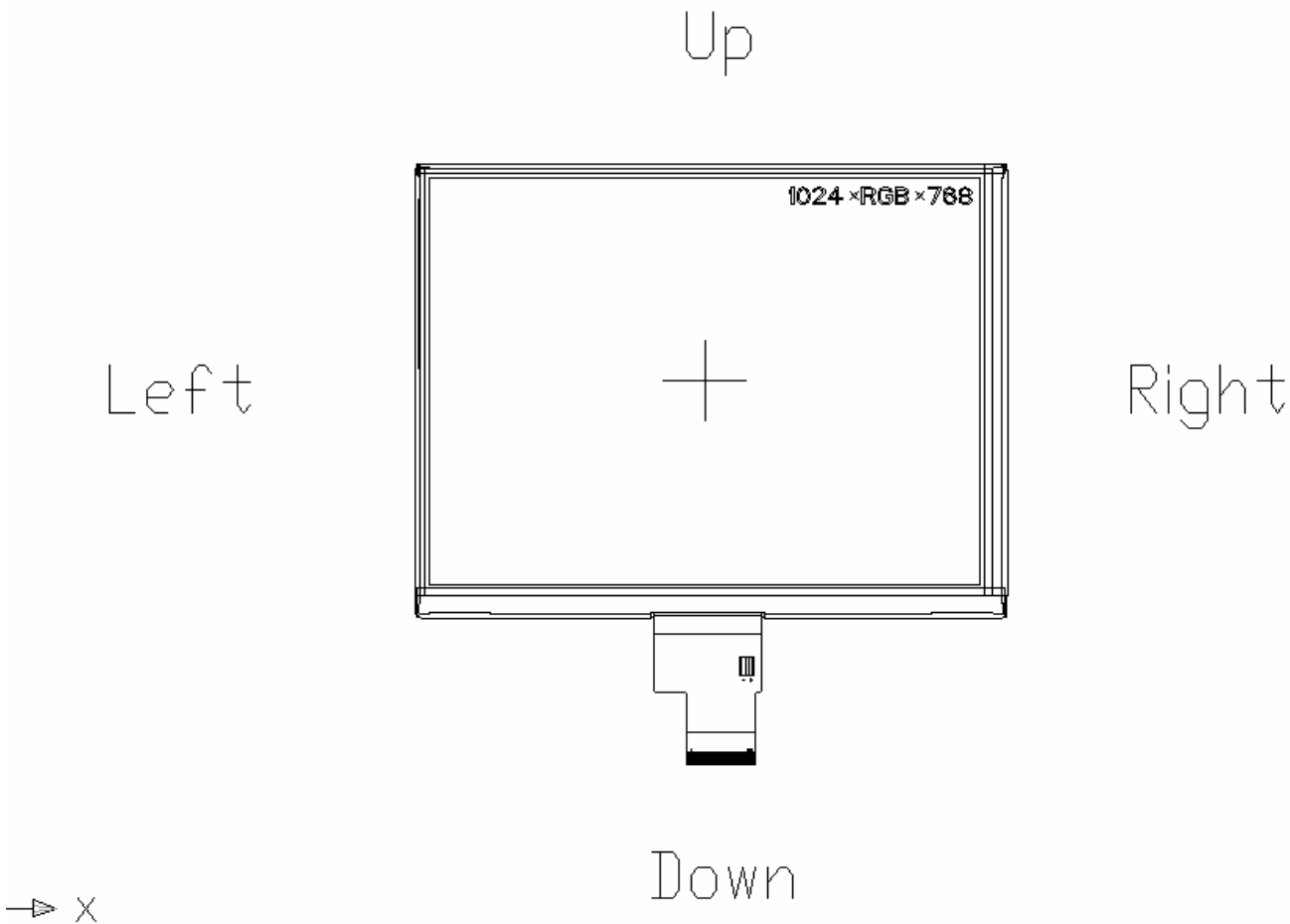
Note :

Maker:JST

Input connector : SHR-02V-S AWG#28 1.0A

Outlet connector: SSH-003T-P0.2-H

Note: Definition of scanning direction.
Refer to the figure as below:



3. Operation Specifications

3.1. Absolute Maximum Ratings

(GND=AV_{SS}=0V,Note 1)

Item	Symbol	Values		Unit	Remark
		Min.	Max.		
Power voltage	VCC	-0.3	5.0	V	GND=0V, TA=25℃
	AVDD	6.5	13.5	V	
	V _{GH}	-0.3	40.0	V	
	V _{GL}	-20.0	0.3	V	
	V _{GH} -V _{GL}	-	40.0	V	
Operation Temperature	T _{OP}	-10	60	℃	
Storage Temperature	T _{ST}	-20	70	℃	
LED Reverse Voltage	V _R	-	5	V	Each LED
LED Forward Current	I _F	-	35	mA	Each LED

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

3.2. Typical Operation Conditions

(GND=AV_{SS}=0V, Note 1)

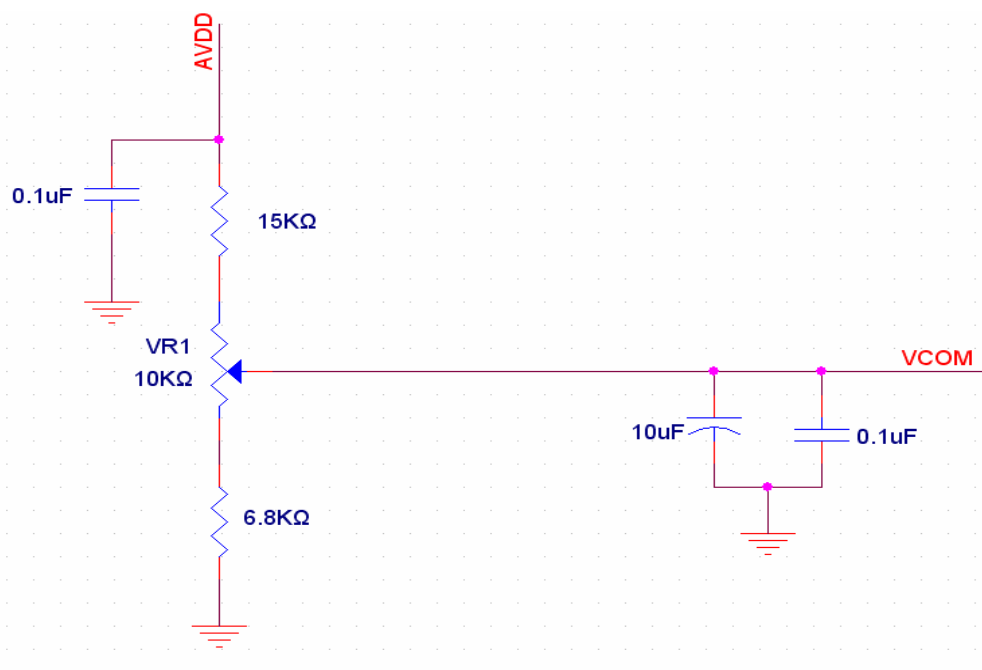
Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Power voltage	V _{CC}	3.0	3.3	3.6	V	Note 2
	AV _{DD}	9.8	10	10.2	V	
	V _{GH}	18.6	18.9	19.2	V	
	V _{GL}	-8.1	-7.8	-7.5	V	
Input signal voltage	V _{COM}	2.6	3.6	4.6	V	Note 3
Input logic high voltage	V _{IH}	0.7V _{CC}	-	V _{CC}	V	Note 4
Input logic low voltage	V _{IL}	0	-	0.3V _{CC}	V	

Note 1: Be sure to apply V_{DD} and V_{GL} to the LCD first, and then apply V_{GH}

Note 2: V_{DD} setting should match the signals output voltage (refer to Note 3) of customer's system board.

Note 3: Typical V_{com} is only a reference value, it must be optimized according to each LCM, please use VR and base on below application circuit..

Note 4: RESET, STBYB, SELB, L/R, U/D, CAB_{CEN0}, CAB_{CEN1}.



3.3. Current Consumption

(GND=AVSS=0V)

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Current for Driver	I _{GH}	-	0.65	1.0	mA	V _{GH} =18.9V
	I _{GL}	-	0.65	1.0	mA	V _{GL} =-7.8V
	I _{CC}	-	35	60	mA	V _{CC} =3.3V
	I _{AVDD}	-	25	40	mA	AVDD=10.0V

3.4. Backlight Driving Conditions

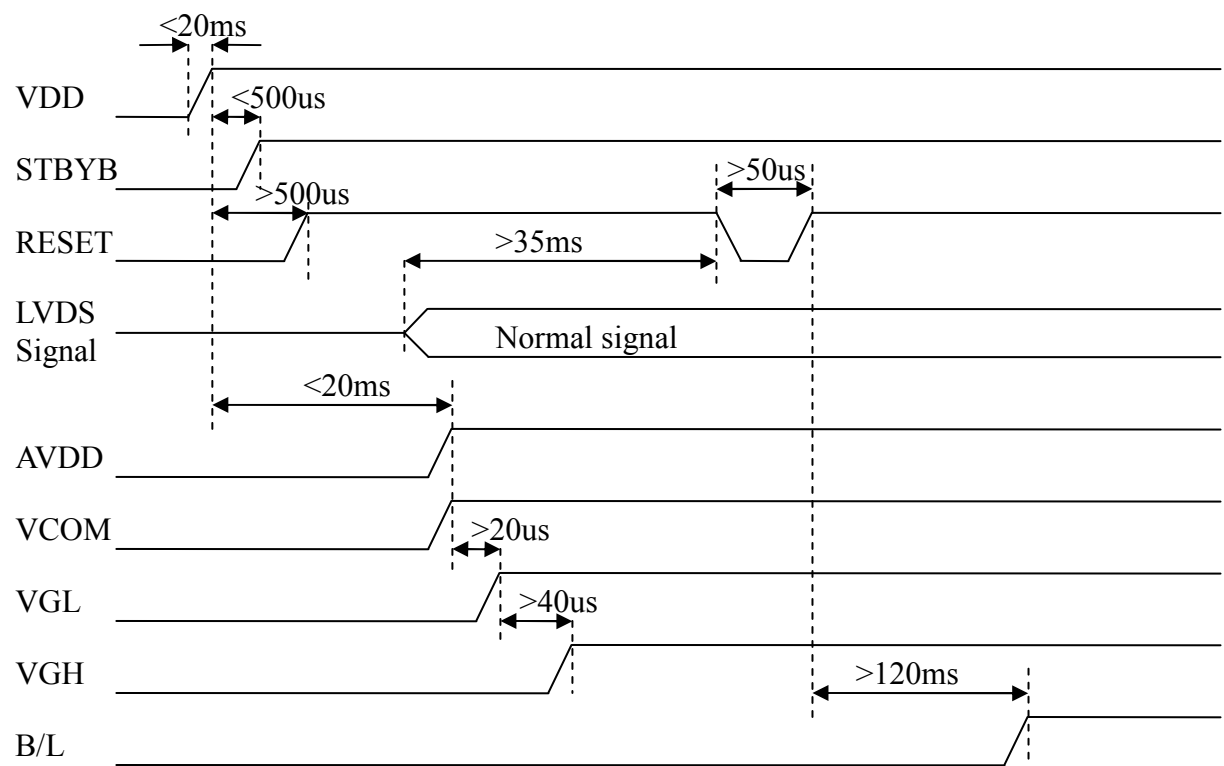
Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED backlight	V _L	8.60	9.80	10.60	V	Note 1
Current for LED backlight	I _L	500	540	-	mA	
LED life time	-	-	30,000	-	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and I_L =540mA.

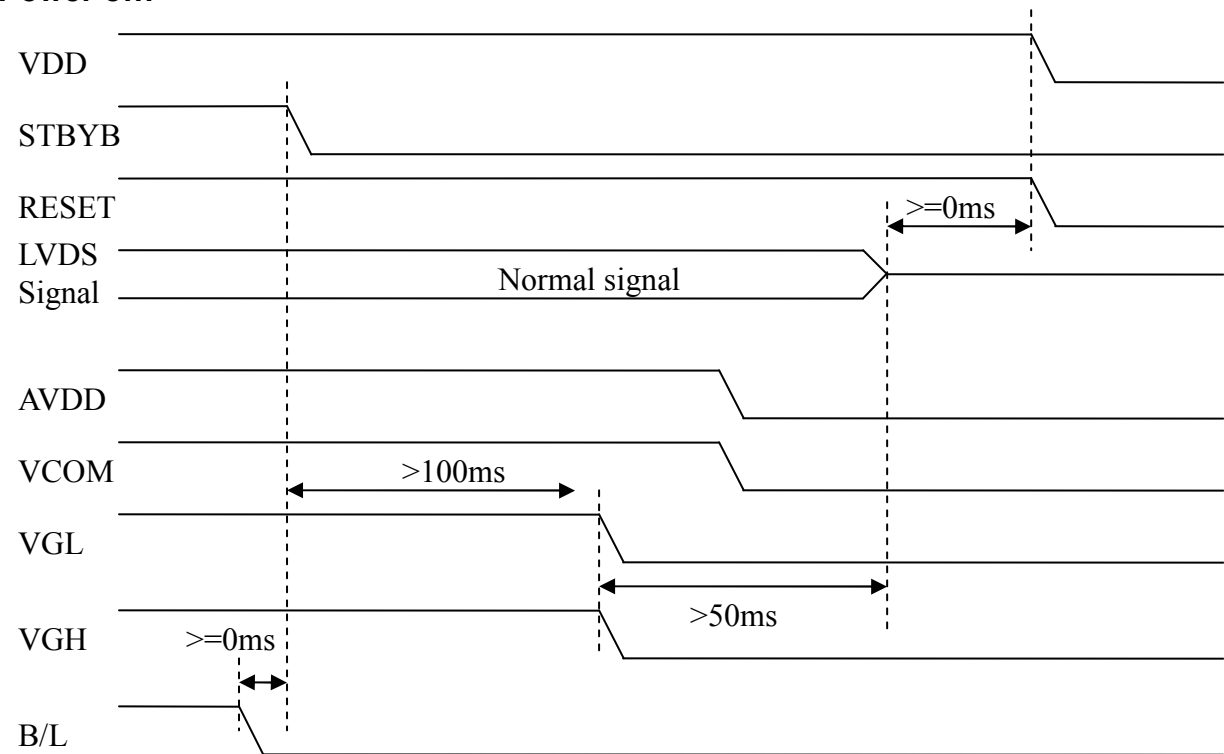
Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_L =540mA. The LED lifetime could be decreased if operating I_L is larger than 540mA.

3.5. Power Sequence

a. Power on:



b. Power off:

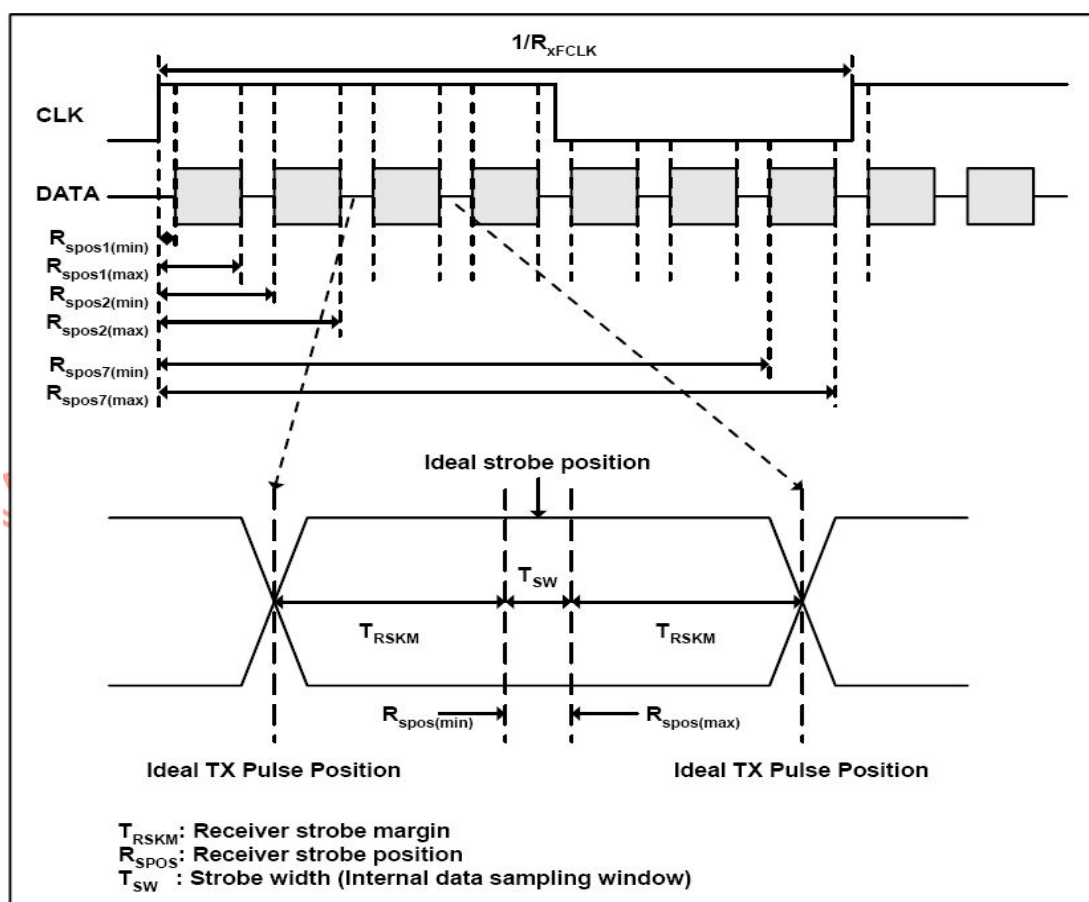


3.6. LVDS Signal Timing Characteristics

3.6.1. AC Electrical Characteristics

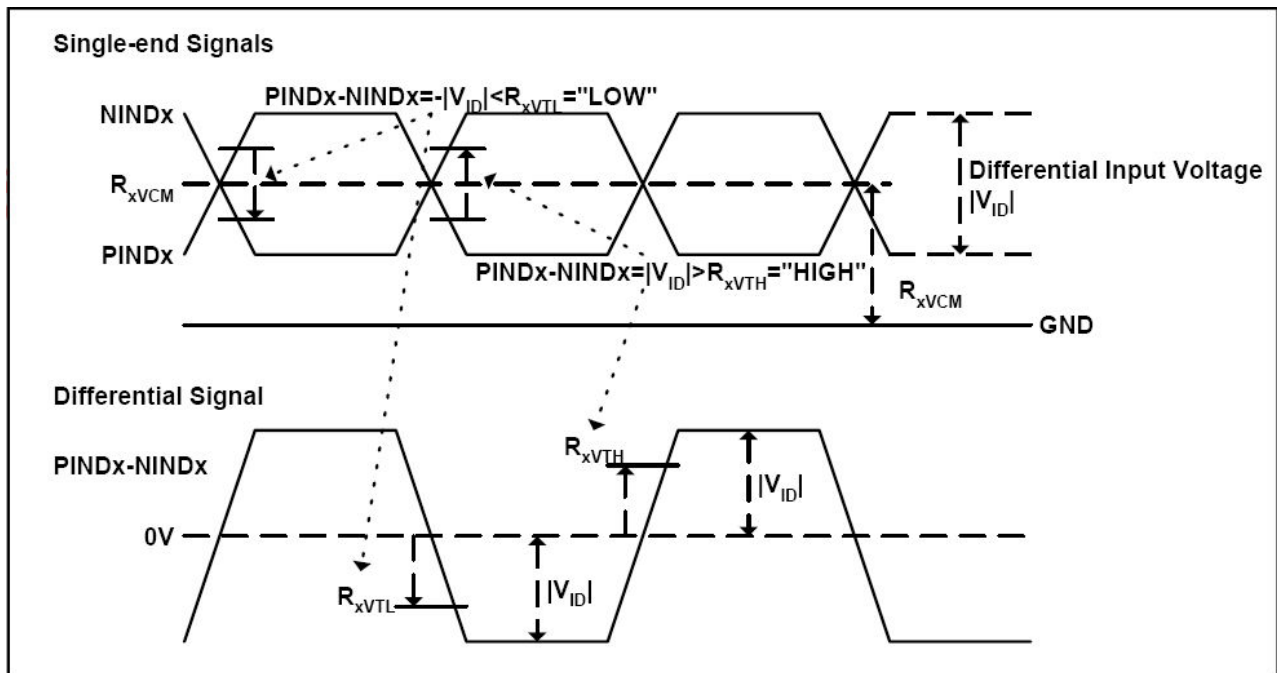
Parameter	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Clock frequency	R_{xFCLK}	20	-	71	MHz	
Input data skew margin	T_{RSKM}	500	-	-	ps	
Clock high time	T_{LVCH}	-	$4/(7 * R_{xFCLK})$	-	ns	
Clock low time	T_{LVCL}	-	$3/(7 * R_{xFCLK})$	-	ns	

3.6.2. Input Clock and Data Timing Diagram



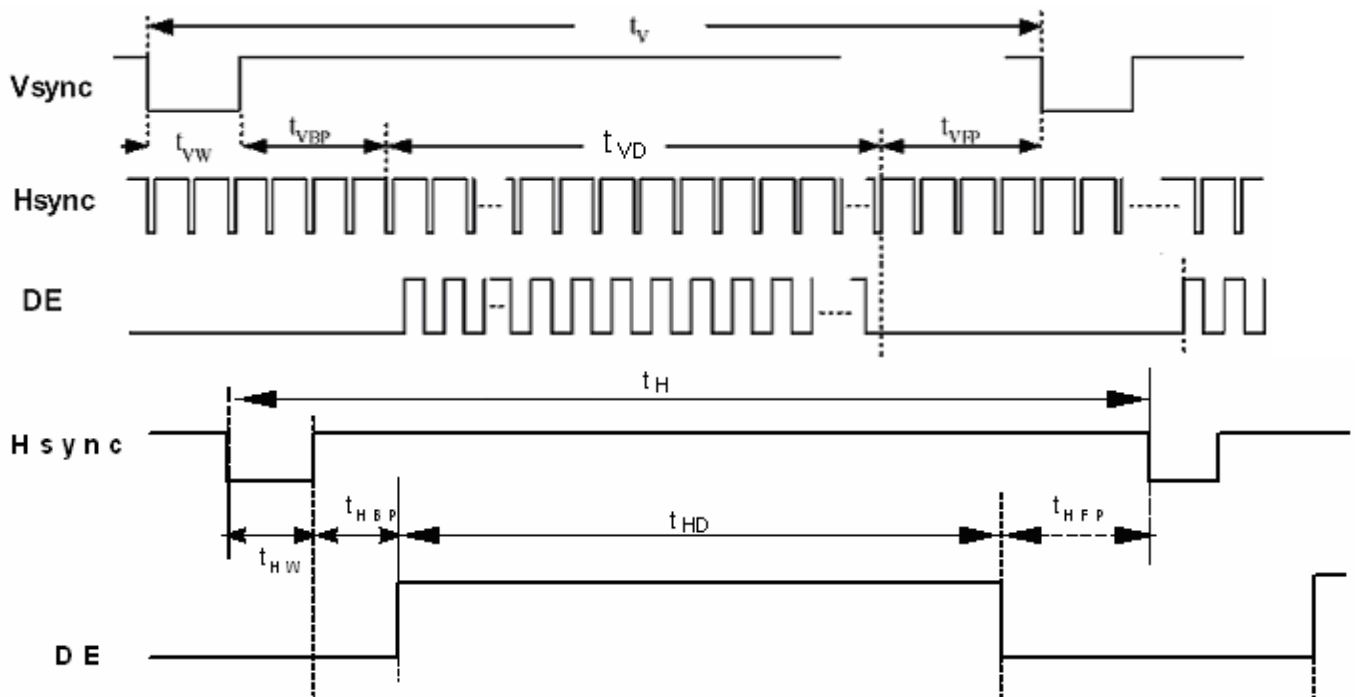
3.6.3. DC Electrical Characteristics

Parameter	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Differential input high Threshold voltage	R_{xVTH}	-	-	+0.1	V	$R_{xVCM}=1.2V$
Differential input low Threshold voltage	R_{xVTL}	-0.1	-	-	V	
Input voltage range (singled-end)	R_{xVIN}	0	-	2.4	V	
Differential input common mode voltage	R_{xVCM}	$ V_{ID} /2$	-	$2.4- V_{ID} /2$	V	
Differential voltage	$ V_{ID} $	0.2	-	0.6	V	
Differential input leakage current	RV_{xliz}	-10	-	+10	uA	



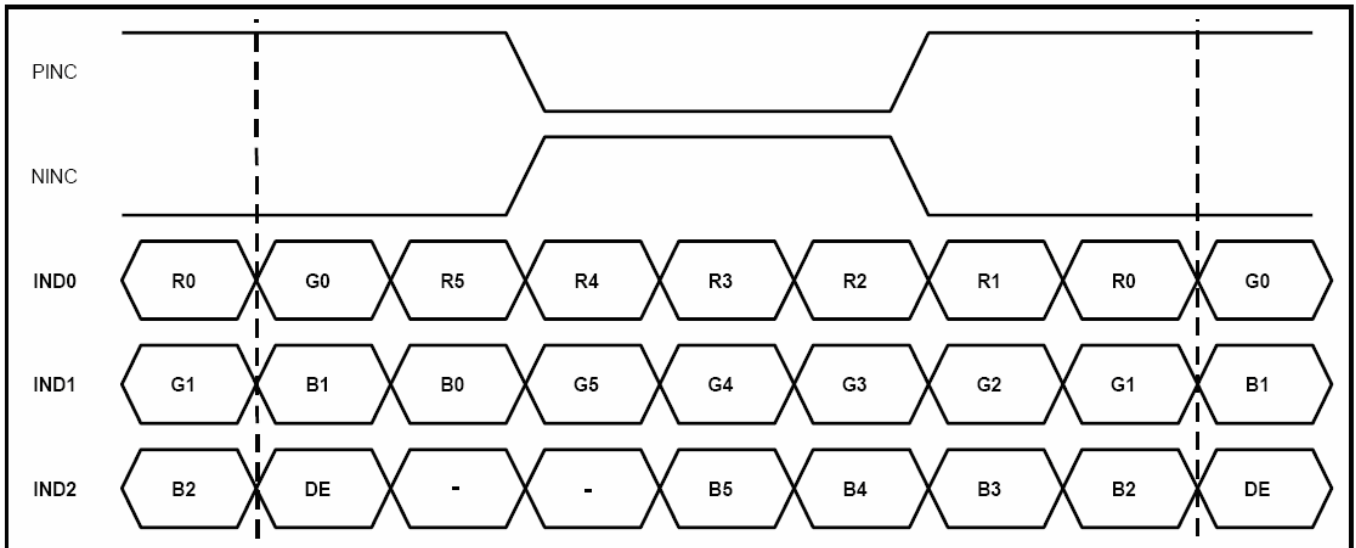
3.6.4. Timing Table

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Clock Frequency	fclk	52	65	71	MHz	Frame rate =TBD
Horizontal display area	thd	1024				
HS period time	th	1114	1344	1400	DCLK	
HS Blanking	thb+thfp	90	320	376	DCLK	
Vertical display area	tvd	768				
VS period time	tv	778	806	845	H	
VS Blanking	tvb+tvfp	10	38	77	H	

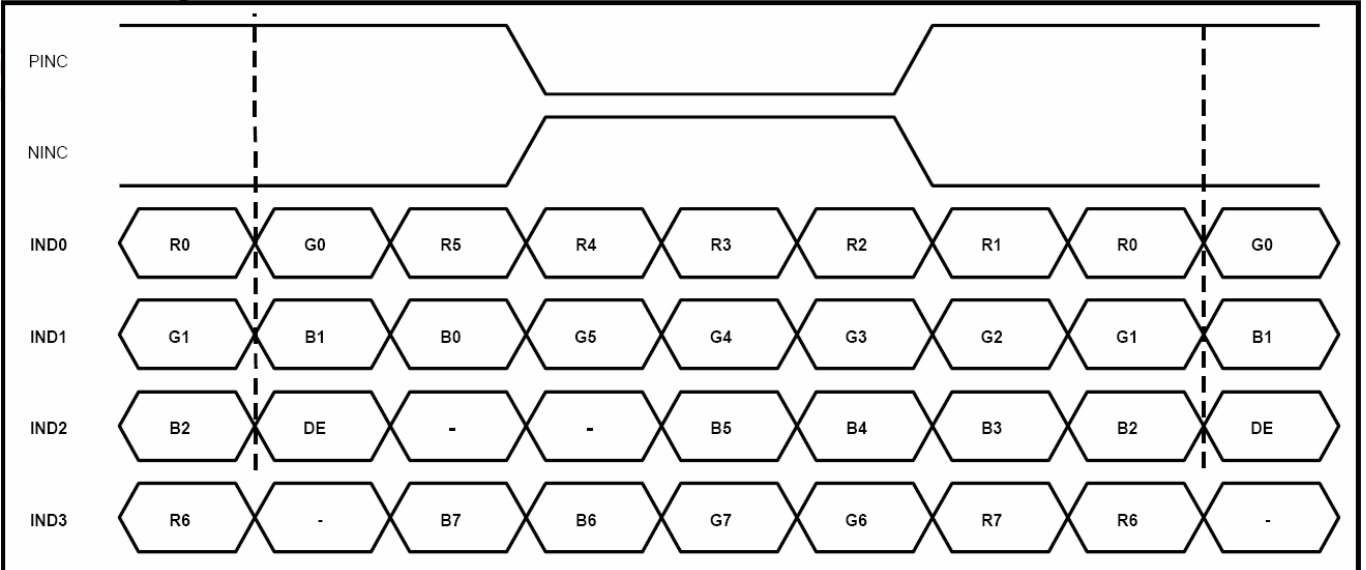


3.6.5. Data Input Format

6bit LVDS input



8bit LVDS input



Note: Support DE timing mode only, SYNC mode not supported

4. Optical Specifications

Item	Symbol	Condition	Values			Unit	Remark
			Min.	Typ.	Max.		
Viewing angle (CR≥ 10)	θ_L	$\Phi=180^\circ$ (9 o'clock)	75	85	-	degree	
	θ_R	$\Phi=0^\circ$ (3 o'clock)	75	85	-		
	θ_T	$\Phi=90^\circ$ (12 o'clock)	75	85	-		
	θ_B	$\Phi=270^\circ$ (6 o'clock)	75	85	-		
Response time	T_{ON}	Normal $\theta=\Phi=0^\circ$	-	25	50	msec	
	T_{OFF}						
Contrast ratio	CR		600	800	-	-	
Color chromaticity	W_X		0.260	0.295	0.330	-	
	W_Y		0.270	0.305	0.340	-	
Luminance	L		800	1000	-	cd/m2	
Luminance uniformity	Y_U		75	80	-	%	
NTSC				50		%	

Test Conditions:

1. $DV_{DD}=3.1V$, $I_L=540mA$ (Backlight current), the ambient temperature is $25^\circ C$.
2. The test systems refer to Note 2.

5. Reliability Test Items

(Note3)

Item	Test Conditions	Remark
High Temperature Storage	Ta = 70℃ 240hrs	Note 1, Note 4
Low Temperature Storage	Ta = -20℃ 240hrs	Note 1, Note 4
High Temperature Operation	Ts = 60℃ 240hrs	Note 2, Note 4
Low Temperature Operation	Ta = -10℃ 240hrs	Note 1, Note 4
Operate at High Temperature and Humidity	+40℃, 90%RH 240hrs	Note 4
Thermal Shock	-10℃/30 min ~ +50℃/30 min for a total 100 cycles, Start with cold temperature and end with high temperature.	Note 4
Vibration Test	Frequency range:10~55Hz Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X. Y. Z. (6 hours for total)	
Mechanical Shock	100G 6ms,±X, ±Y, ±Z 3 times for each direction	
Package Vibration Test	Sine wave, 10~50~10Hz 1.5G, 0.37oct/min 3 axis, 1hour/axis	
Package Drop Test	Height:60 cm 1 corner, 3 edges, 6 surfaces	

Note 1: Ta is the ambient temperature of samples.

Note 2: Ts is the temperature of panel's surface.

Note 3: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

Note 4: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.

6. General Precautions

6.1 Safety

The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

6.2 Handling

- A. The LCD and touch panel is made of plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- B. Do not handle the product by holding the flexible pattern portion in order to assure the reliability
- C. Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.
- D. Provide a space so that the panel does not come into contact with other components.
- E. To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- F. Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.
- G. Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- H. To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

6.3 Static Electricity

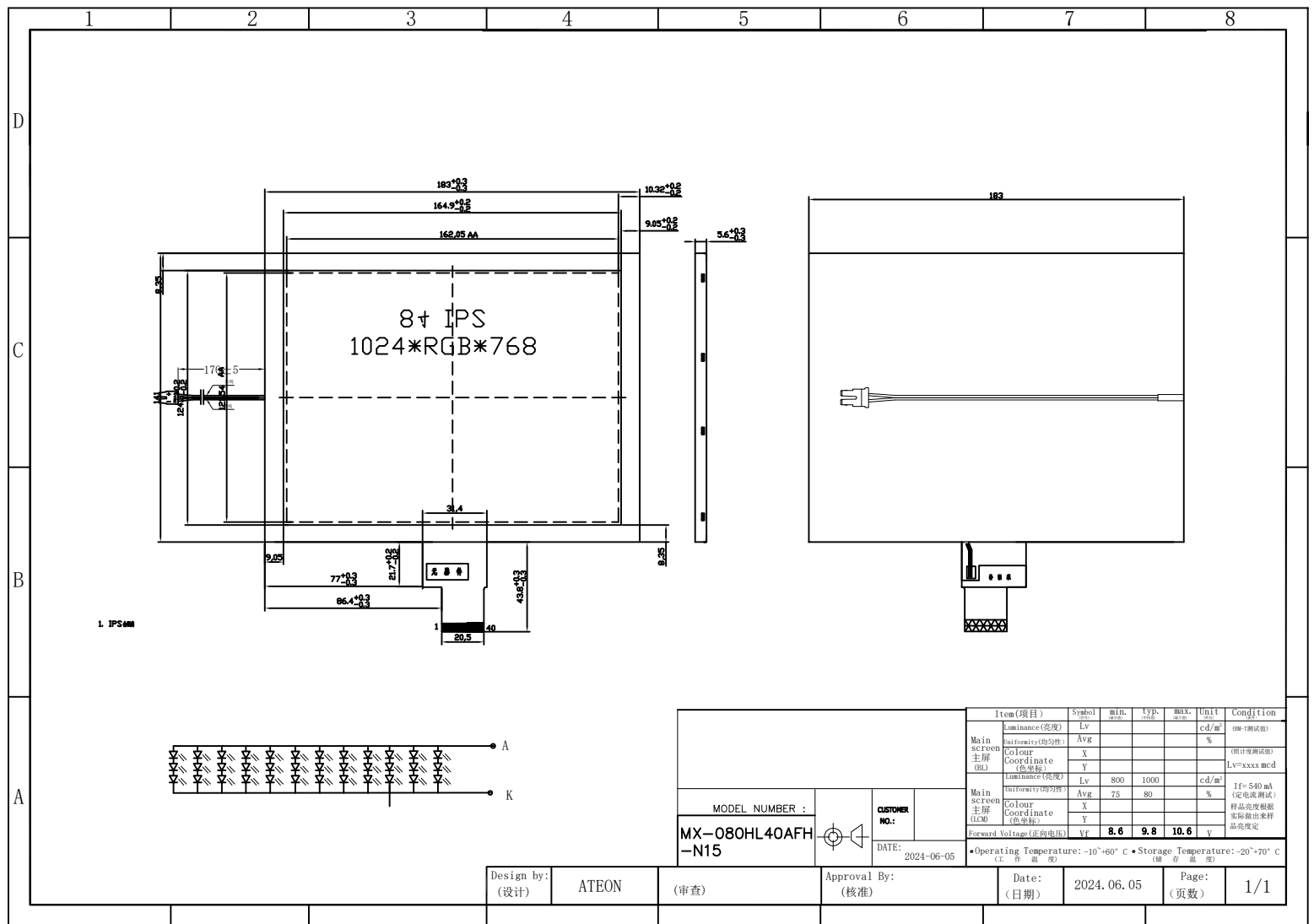
- A. Ground soldering iron tips, tools and testers when they are in operation.
- B. Ground your body when handling the products.
- C. Power on the LCD module before applying the voltage to the input terminals.
- D. Do not apply voltage which exceeds the absolute maximum rating.
- E. Store the products in an anti-electrostatic bag or container.

6.4 Storage

- A. Store the products in a dark place at $+25^{\circ}\text{C}\pm 10^{\circ}\text{C}$ with low humidity (40% RH to 60% RH). Don't expose to sunlight or fluorescent light.
- B. Storage in a clean environment, free from dust, active gas, and solvent.

6.5 Cleaning

- A. Do not wipe the touch panel with dry cloth, as it may cause scratch.
- B. Wipe off the stain on the product by using soft cloth moistened with ethanol. Do not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.



8. Package Information

8.1 LCM quantity per Carton: 60 pcs

8.2 Package drawing:TBD